

General Description

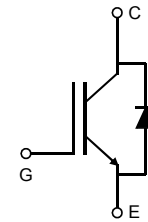
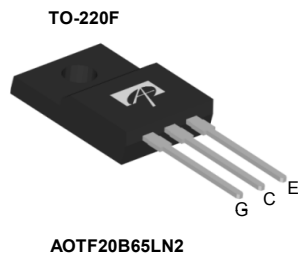
- Latest AlphaIGBT (αIGBT) technology
- 650V Breakdown voltage
- Very low VCE(sat)
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low Turn-Off switching loss and softness
- Very good EMI behavior

Applications

- Motor Drives
- Power Tools and Sewing Machines
- Mid to High Range Switching Frequency Converters
- Other Hard Switching Applications

Product Summary

| | |
|--|-------|
| V_{CE} | 650V |
| I_C ($T_C=100^\circ\text{C}$) | 20A |
| $V_{CE(sat)}$ ($T_J=25^\circ\text{C}$) | 1.54V |



| Orderable Part Number | Package Type | Form | Minimum Order Quantity |
|-----------------------|--------------|------|------------------------|
| AOTF20B65LN2 | TO220F | Tube | 1000 |

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | AOTF20B65LN2 | Units |
|--|----------------|-------------------------|-------------------|
| Collector-Emitter Voltage | V_{CE} | 650 | V |
| Gate-Emitter Voltage | V_{GE} | ± 30 | V |
| Continuous Collector Current | I_C | $T_C=25^\circ\text{C}$ | 40 ⁽²⁾ |
| | | $T_C=100^\circ\text{C}$ | 20 ⁽²⁾ |
| Pulsed Collector Current, Limited by T_{Jmax} | I_{CM} | 60 | A |
| Turn off SOA, $V_{CE} \leq 650\text{V}$, Limited by T_{Jmax} | I_{LM} | 60 | A |
| Continuous Diode Forward Current | I_F | $T_C=25^\circ\text{C}$ | 40 ⁽²⁾ |
| | | $T_C=100^\circ\text{C}$ | 20 ⁽²⁾ |
| Diode Pulsed Current, Limited by T_{Jmax} | I_{FM} | 60 | A |
| Power Dissipation | P_D | $T_C=25^\circ\text{C}$ | 45 |
| | | $T_C=100^\circ\text{C}$ | 18 |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | $^\circ\text{C}$ |
| Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds | T_L | 300 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | AOTF20B65LN2 | Units |
|--------------------------------|-----------------|--------------|--------------------|
| Maximum Junction-to-Ambient | $R_{\theta JA}$ | 65 | $^\circ\text{C/W}$ |
| Maximum IGBT Junction-to-Case | $R_{\theta JC}$ | 2.8 | $^\circ\text{C/W}$ |
| Maximum Diode Junction-to-Case | $R_{\theta JC}$ | 3.2 | $^\circ\text{C/W}$ |

1) TO220F I_C follows TO220/TO263.

Electrical Characteristics (T_J=25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units | |
|--|--------------------------------------|---|---|------|------|-------|----|
| STATIC PARAMETERS | | | | | | | |
| BV _{CES} | Collector-Emitter Breakdown Voltage | I _C =1mA, V _{GE} =0V, T _J =25°C | 650 | - | - | V | |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | V _{GE} =15V, I _C =20A | T _J =25°C | - | 1.54 | 1.95 | V |
| | | | T _J =125°C | - | 1.83 | - | |
| | | | T _J =150°C | - | 1.91 | - | |
| V _F | Diode Forward Voltage | V _{GE} =0V, I _F =20A | T _J =25°C | - | 1.6 | 2.1 | V |
| | | | T _J =125°C | - | 1.66 | - | |
| | | | T _J =150°C | - | 1.63 | - | |
| V _{GE(th)} | Gate-Emitter Threshold Voltage | V _{CE} =5V, I _C =1mA | - | 4.7 | - | V | |
| I _{CES} | Zero Gate Voltage Collector Current | V _{CE} =650V, V _{GE} =0V | T _J =25°C | - | - | 10 | μA |
| | | | T _J =125°C | - | - | 500 | |
| | | | T _J =150°C | - | - | 1000 | |
| I _{GES} | Gate-Emitter leakage current | V _{CE} =0V, V _{GE} =±30V | - | - | ±100 | nA | |
| g _{FS} | Forward Transconductance | V _{CE} =20V, I _C =20A | - | 19 | - | S | |
| DYNAMIC PARAMETERS | | | | | | | |
| C _{ies} | Input Capacitance | V _{GE} =0V, V _{CC} =25V, f=1MHz | - | 1237 | - | pF | |
| C _{oes} | Output Capacitance | | - | 124 | - | pF | |
| C _{res} | Reverse Transfer Capacitance | | - | 38 | - | pF | |
| Q _g | Total Gate Charge | V _{GE} =15V, V _{CC} =520V, I _C =20A | - | 52 | - | nC | |
| Q _{ge} | Gate to Emitter Charge | | - | 14 | - | nC | |
| Q _{gc} | Gate to Collector Charge | | - | 22 | - | nC | |
| R _g | Gate resistance | V _{GE} =0V, V _{CC} =0V, f=1MHz | - | 11 | - | Ω | |
| SWITCHING PARAMETERS, (Load Inductive, T_J=25°C) | | | | | | | |
| T _{d(on)} | Turn-On Delay Time | T _J =25°C V _{GE} =15V, V _{CC} =400V, I _C =20A, R _G =15Ω | - | 23 | - | ns | |
| T _r | Turn-On Rise Time | | - | 23 | - | ns | |
| T _{d(off)} | Turn-Off Delay Time | | - | 135 | - | ns | |
| T _f | Turn-Off Fall Time | | - | 12 | - | ns | |
| E _{on} | Turn-On Energy | | - | 0.45 | - | mJ | |
| E _{off} | Turn-Off Energy | | - | 0.26 | - | mJ | |
| E _{total} | Total Switching Energy | | - | 0.71 | - | mJ | |
| T _{rr} | Diode Reverse Recovery Time | | T _J =25°C | - | 266 | - | ns |
| Q _{rr} | Diode Reverse Recovery Charge | | I _F =20A, dl/dt=200A/μs, V _{CC} =400V | - | 0.6 | - | μC |
| I _{rm} | Diode Peak Reverse Recovery Current | | - | 5.4 | - | A | |
| SWITCHING PARAMETERS, (Load Inductive, T_J=150°C) | | | | | | | |
| T _{d(on)} | Turn-On Delay Time | T _J =150°C V _{GE} =15V, V _{CC} =400V, I _C =20A, R _G =15Ω | - | 22 | - | ns | |
| T _r | Turn-On Rise Time | | - | 24 | - | ns | |
| T _{d(off)} | Turn-Off Delay Time | | - | 160 | - | ns | |
| T _f | Turn-Off Fall Time | | - | 20 | - | ns | |
| E _{on} | Turn-On Energy | | - | 0.49 | - | mJ | |
| E _{off} | Turn-Off Energy | | - | 0.44 | - | mJ | |
| E _{total} | Total Switching Energy | | - | 0.93 | - | mJ | |
| T _{rr} | Diode Reverse Recovery Time | | T _J =150°C | - | 363 | - | ns |
| Q _{rr} | Diode Reverse Recovery Charge | | I _F =20A, dl/dt=200A/μs, V _{CC} =400V | - | 1.3 | - | μC |
| I _{rm} | Diode Peak Reverse Recovery Current | | - | 6.9 | - | A | |

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

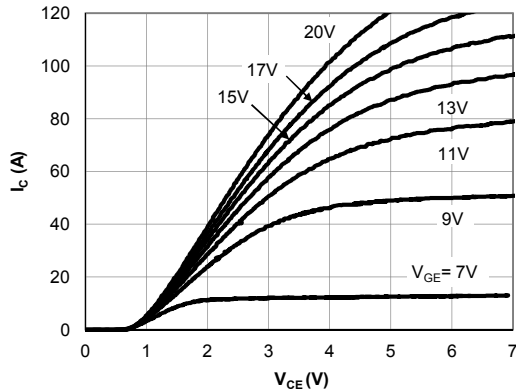


Figure 1: Output Characteristic
($T_j=25^\circ\text{C}$)

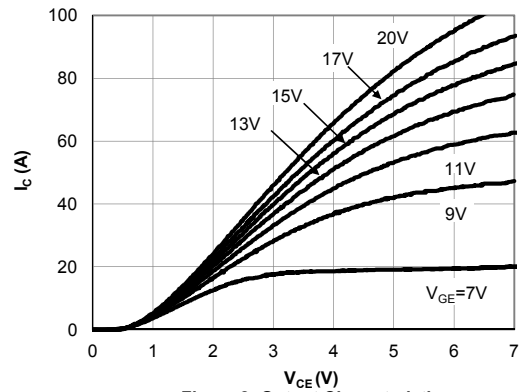


Figure 2: Output Characteristic
($T_j=150^\circ\text{C}$)

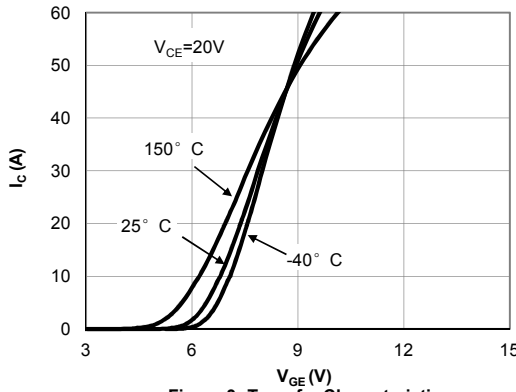


Figure 3: Transfer Characteristic

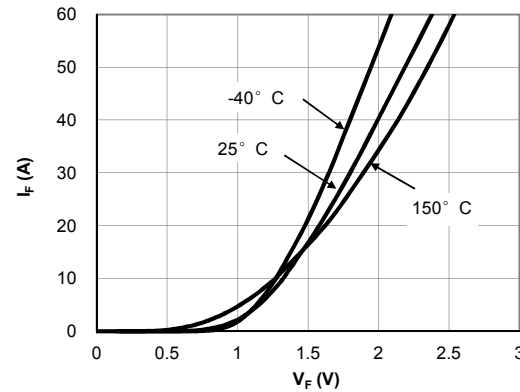


Figure 4: Diode Characteristic

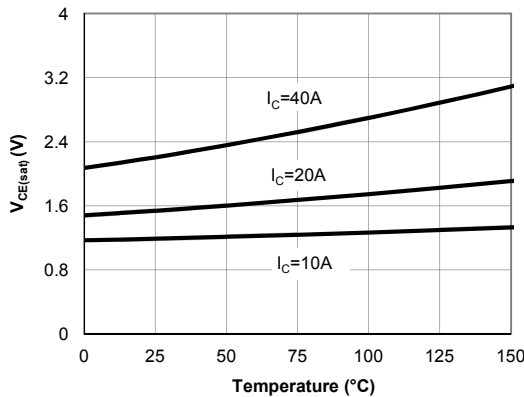


Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

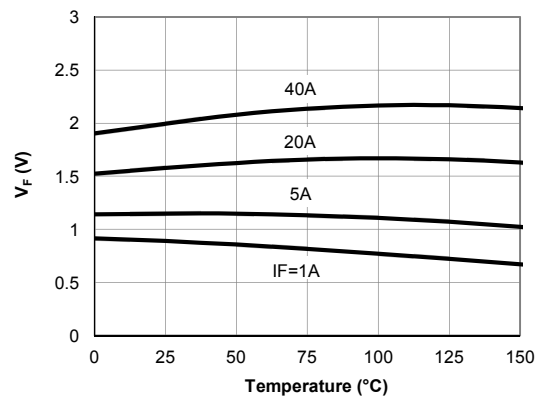


Figure 6: Diode Forward voltage vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

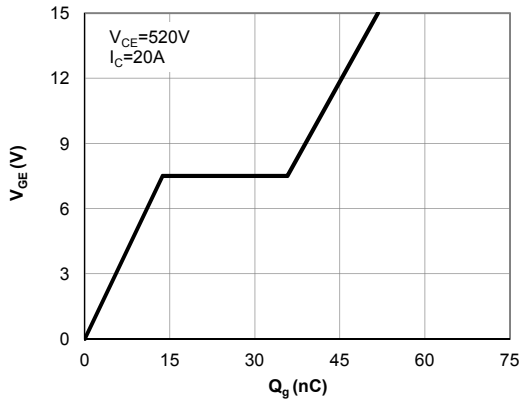


Figure 7: Gate-Charge Characteristics

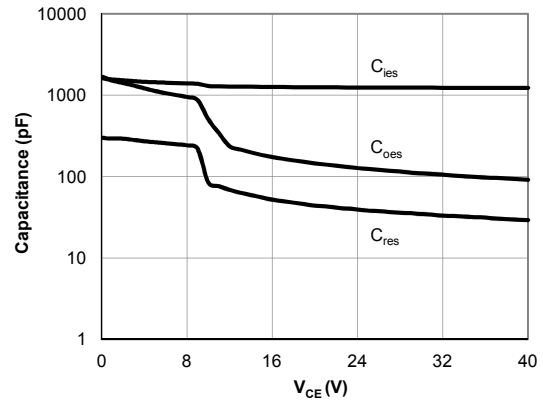


Figure 8: Capacitance Characteristic

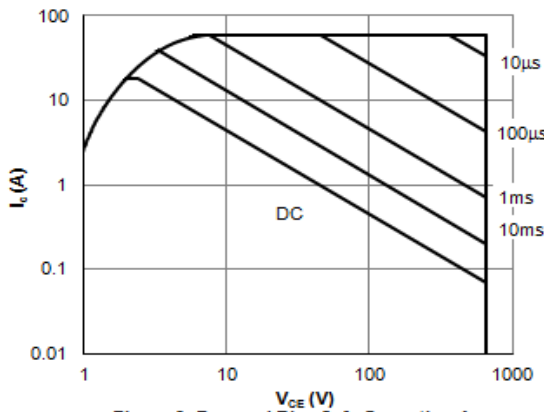


Figure 9: Forward Bias Safe Operating Area
($T_C=25^\circ\text{C}$, $V_{GE}=15\text{V}$)

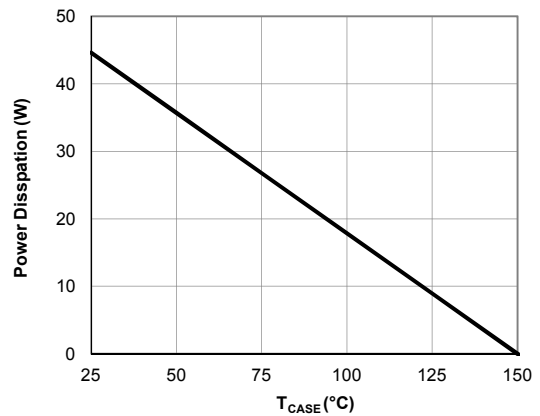


Figure 10: Power Dissipation as a Function of Case

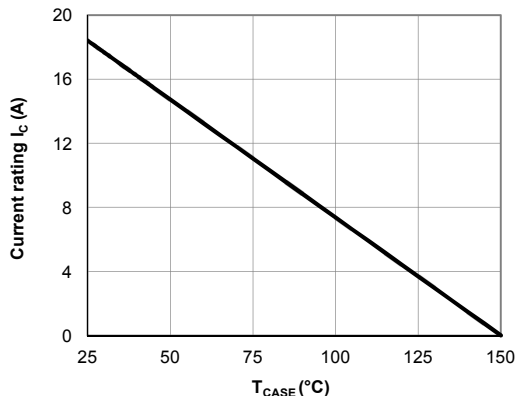


Figure 11: Current De-rating

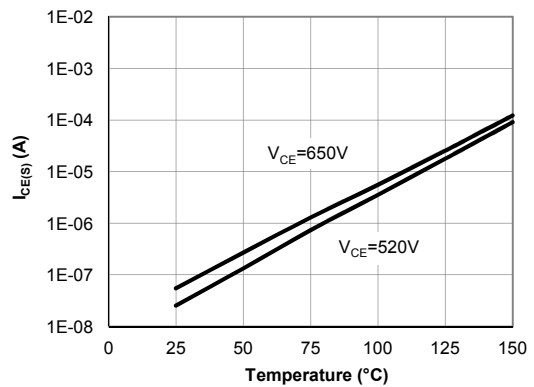


Figure 12: Diode Reverse Leakage Current vs. Junction Temperature

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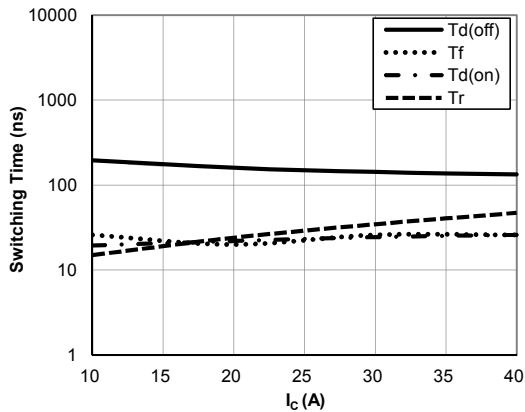


Figure 13: Switching Time vs. I_C
($T_J=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $R_g=15\Omega$)

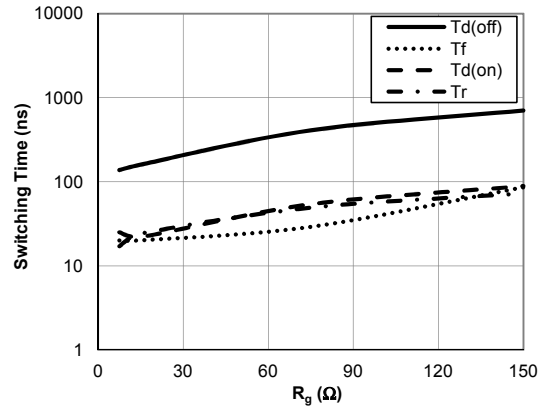


Figure 14: Switching Time vs. R_g
($T_J=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=20\text{A}$)

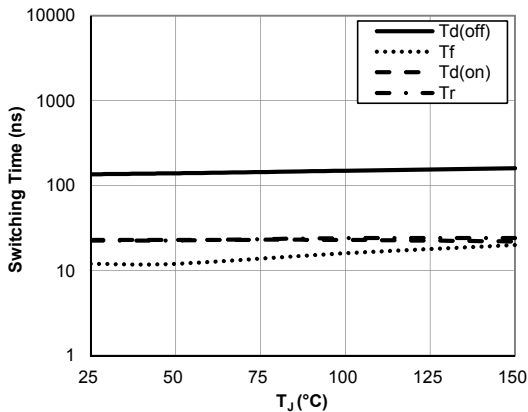


Figure 15: Switching Time vs. T_J
($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=20\text{A}$, $R_g=15\Omega$)

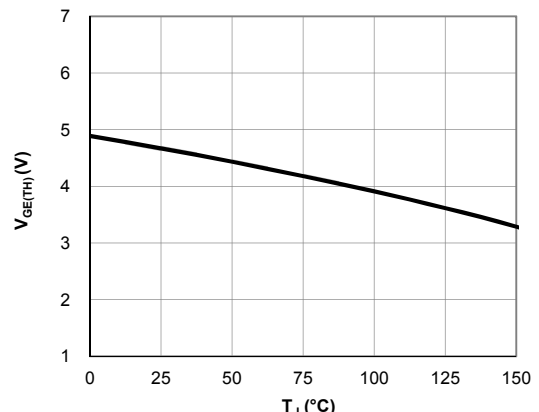


Figure 16: $V_{GE(\text{TH})}$ vs. T_J

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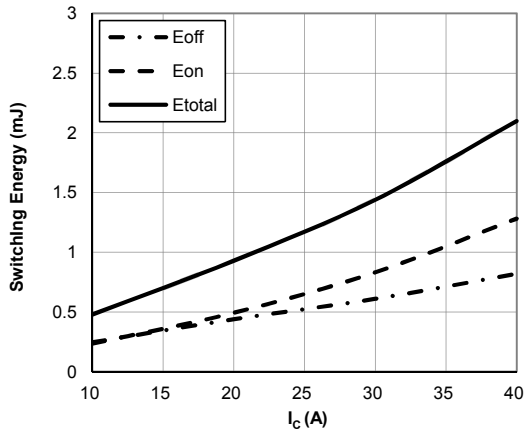


Figure 17: Switching Loss vs. I_c
($T_j=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $R_g=15\Omega$)

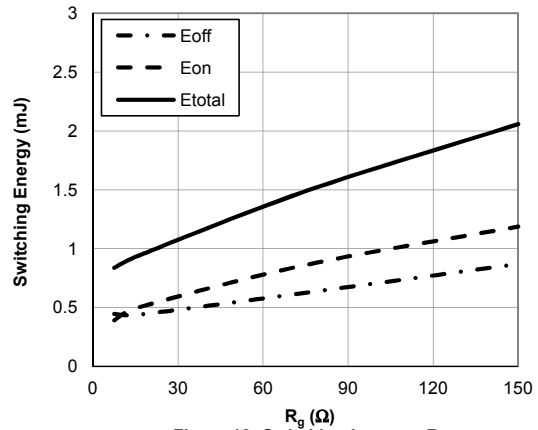


Figure 18: Switching Loss vs. R_g
($T_j=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_c=20\text{A}$)

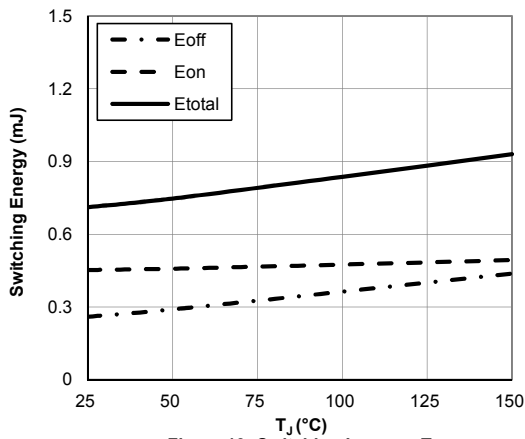


Figure 19: Switching Loss vs. T_j
($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_c=20\text{A}$, $R_g=15\Omega$)

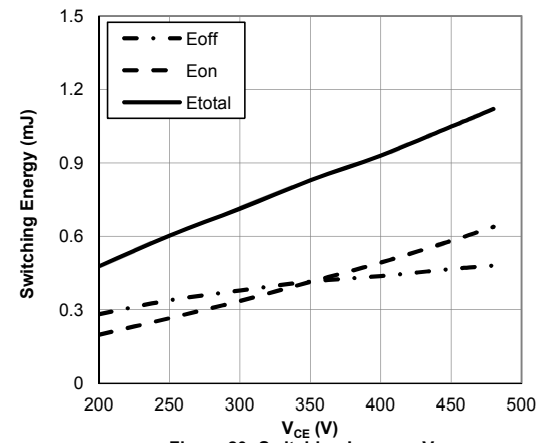


Figure 20: Switching Loss vs. V_{CE}
($T_j=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $I_c=20\text{A}$, $R_g=15\Omega$)

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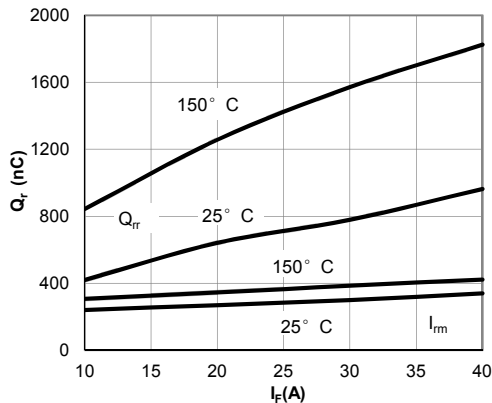


Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

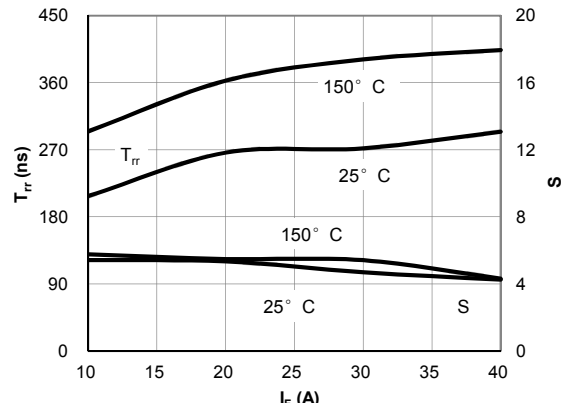


Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

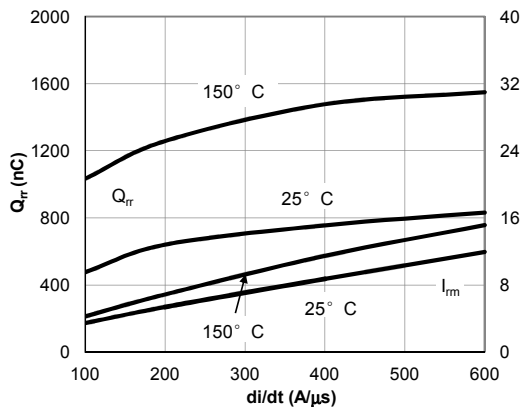


Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_F=20A$)

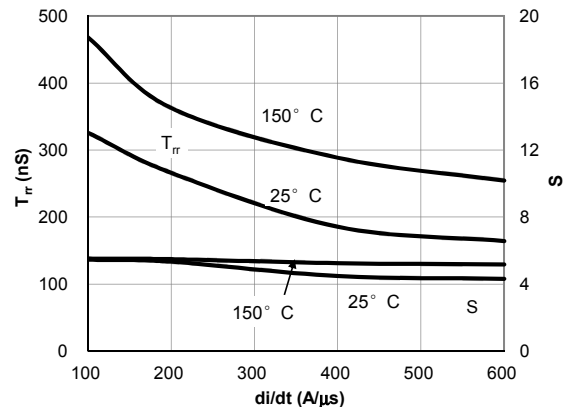


Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_F=20A$)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

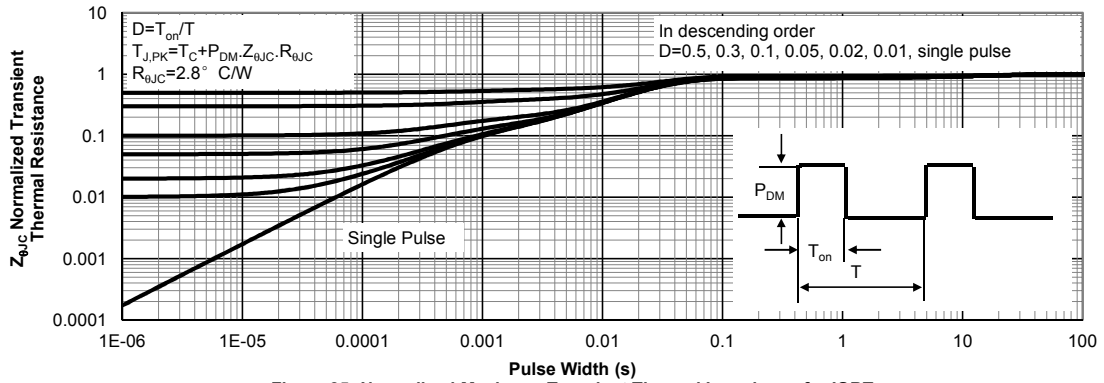


Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT

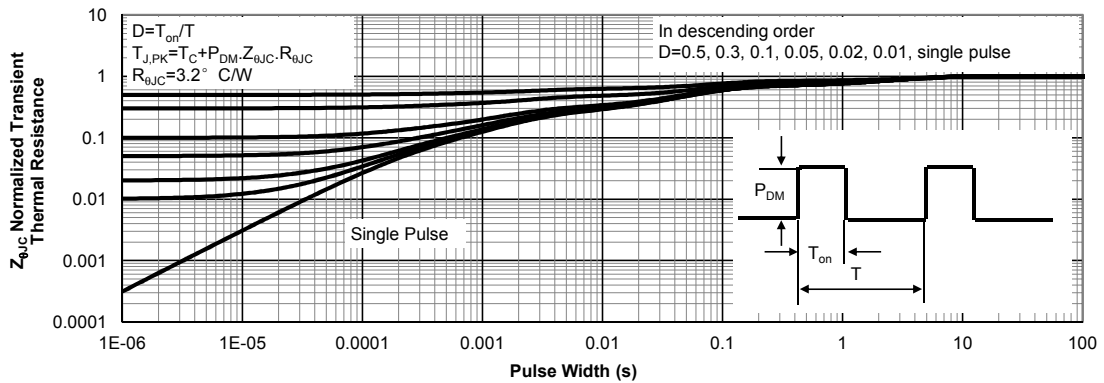


Figure 26: Normalized Maximum Transient Thermal Impedance for Diode

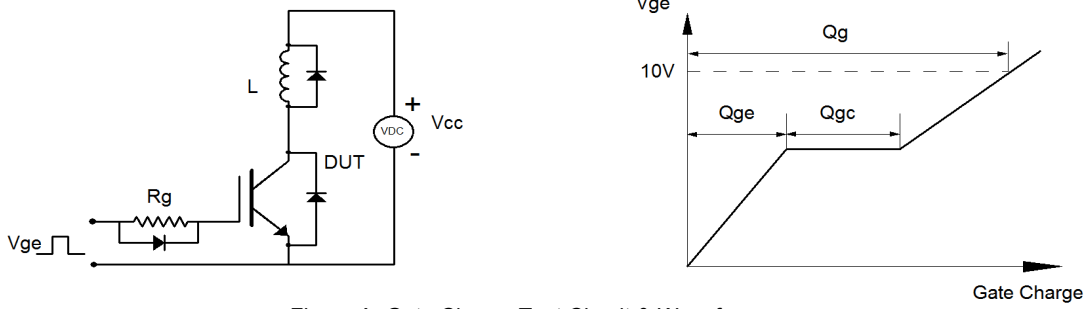


Figure A: Gate Charge Test Circuit & Waveforms

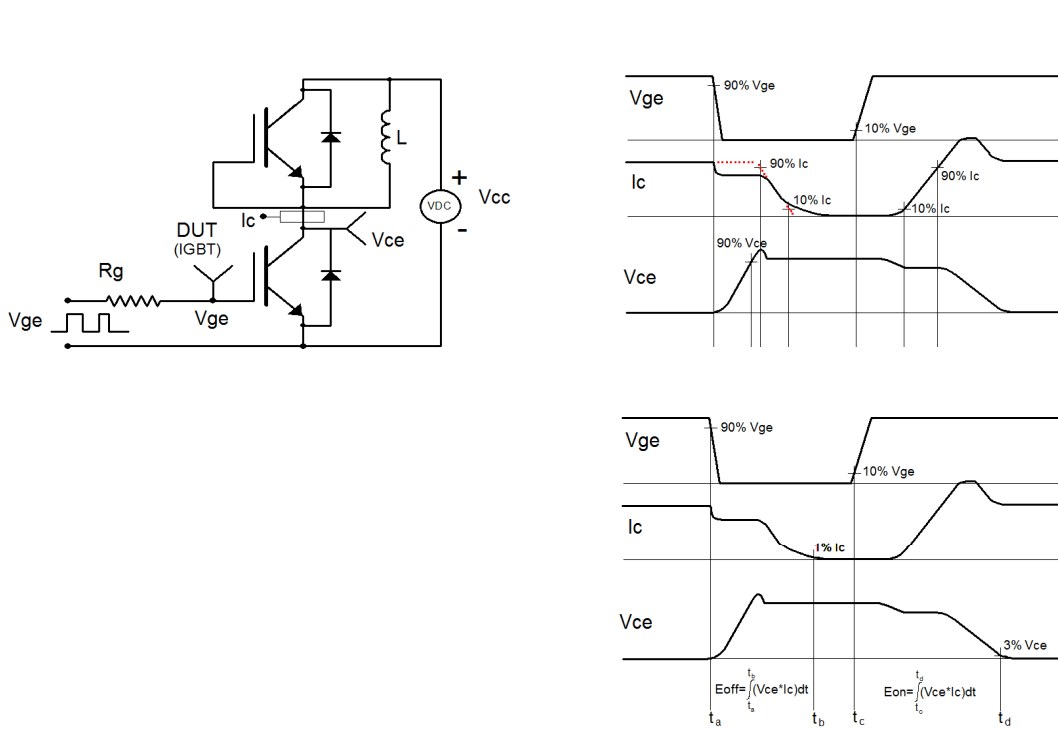


Figure B: Inductive Switching Test Circuit & Waveforms

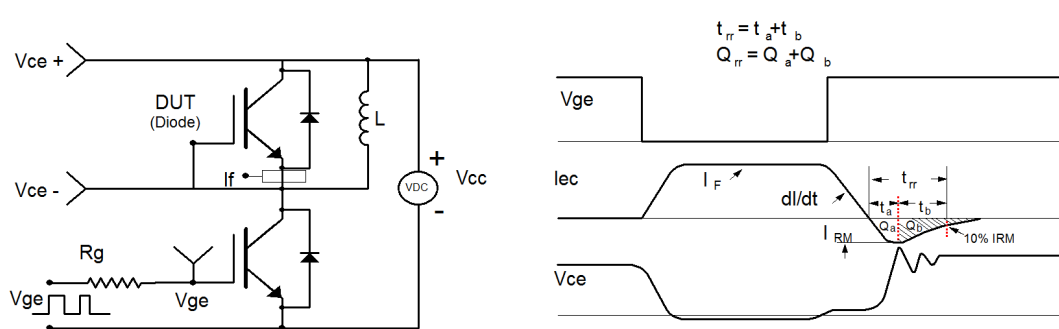


Figure C: Diode Recovery Test Circuit & Waveforms